

## PRM9R0N03N3

# PFC Device Corporation

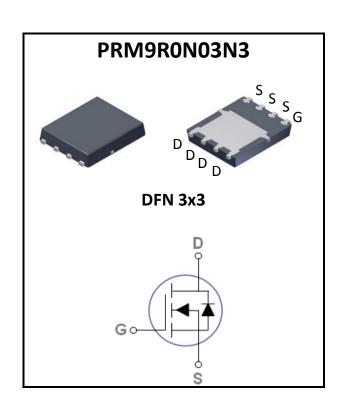
# 30V Single N-Channel MOSFET

### Major ratings and characteristics

Characteristics	Values	Units
$V_{DS}$	30	<b>V</b>
$I_D^4 (T_C=25^{\circ}C)$	53	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	9.0	mΩ
T <sub>J</sub> Operating Junction Temperature	-50 to +150	°C

## **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



## **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

#### **Features**

- Max. R<sub>DS(ON)</sub>=9.0mΩ@V<sub>GS</sub>=10V
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

## 1. Characteristics

**Maximum Ratings Characteristics** 

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	±20	V
$I_D^4$	Drain Current – Continuous (T <sub>C</sub> =25°C)	53	Α
I <sub>D</sub>	Drain Current – Continuous (T <sub>C</sub> =100°C)	33	Α
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	212	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	14	mJ
$I_{AS}$	Single Pulse Avalanche Current <sup>2</sup>	17	Α
В	Power Dissipation (T <sub>C</sub> =25°C)	35	W
$P_D$	Power Dissipation – Derate above 25°C	0.28	W/°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

#### **Thermal Characteristics**

Symbol	Parameter		Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		3.6	°C/W



Version 4.0 2 / 7

#### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

#### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_D$ =250uA	30			<b>V</b>
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V, V_{DS}=0V$			100	nA

#### **On Characteristics**

	R <sub>DS(ON)</sub> Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =16A		7.2	9.0	mΩ	
	$R_{DS(ON)}$		V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A		10.8	13	mΩ
	$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.0	1.6	2.5	<b>V</b>
Ī	<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =20A		42		S

**Dynamic and switching Characteristics** 

	_		1	1	
$Q_g$	Total Gate Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	 7.1		
$Q_gs$	Gate-Source Charge		 3.0		nC
$Q_{gd}$	Gate-Drain Charge		 2.7		
$T_{d(on)}$	Turn-On Delay Time		 6.1		
$T_r$	Turn-On Rise Time	$V_{DD}$ =15V, $V_{GS}$ =10V, $R_{G}$ =3.3 $\Omega$ $I_{D}$ =15A	 62		ns
$T_{d(off)}$	Turn-Off Delay Time		 17		115
$T_f$	Turn-Off Fall Time		 9.5		
$C_{iss}$	Input Capacitance		 838		
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V, f=1MHz	 133		pF
$C_{rss}$	Reverse Transfer Capacitance		 75		
$R_{g}$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	2.7		Ω

#### **Drain-Source Diode Characteristics**

$V_{SD}^{3}$	Source to Drain Diode Voltage	$V_{GS}=0V$ , $I_{S}=1A$	 	1	V
t <sub>rr</sub>	Reverse Recovery Time	1 104 di/dt 1004/up	 7	-	ns
$Q_{rr}$	Reverse Recovery Charge	I <sub>S</sub> =10A, di/dt=100A/us	 0.3		nC

#### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =17A, RG=25 $\Omega$ , Starting TJ=25 $^{\circ}$ C
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.
- 4. Silicon limited.



Version 4.0 3 / 7

## 2. Characteristics Curves

### **Ratings and Characteristics Curves**

## (T<sub>A</sub> = 25°C unless otherwise specified)

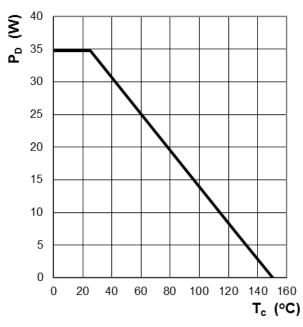


Figure 1: Power Dissipation

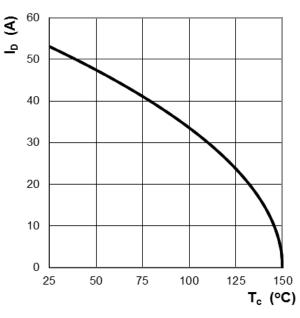


Figure 2: Continuous Drain Current vs. T<sub>C</sub>

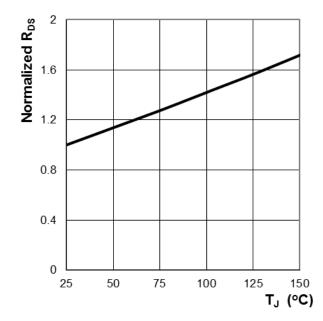


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

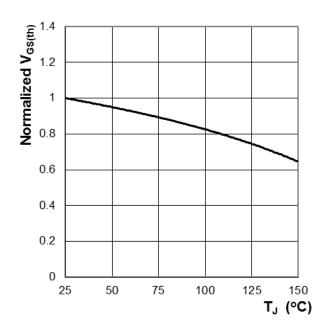


Figure 4: Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>



Version 4.0 4 / 7

**Ratings and Characteristics Curves** 

( $T_A = 25^{\circ}$ C unless otherwise specified)

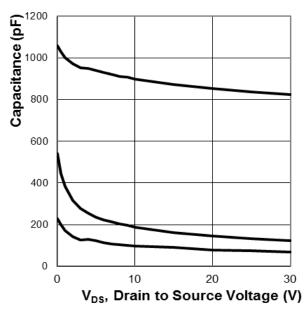


Figure 5: Typ. Capacitance Characteristics

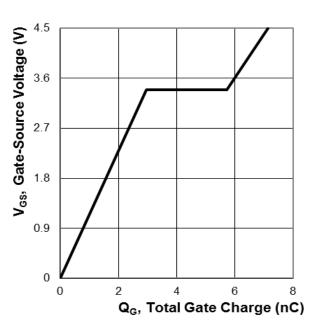


Figure 6: Typ. Gate Charge Characteristics

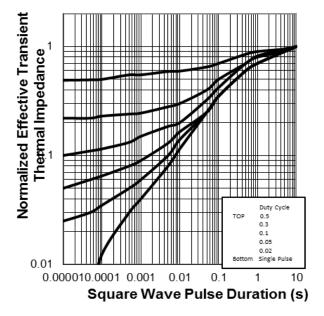
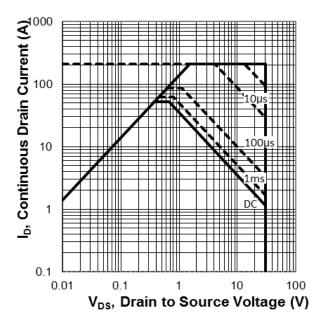


Figure 7: Normalized Thermal Transient Impedance, Junction-to-Case



**Figure 8: Maximum Safe Operation Area** 



Version 4.0 5 / 7

## 3. Marking information

**Top Marking Rule** 

PFC PRM 9R0N03 YM ABS PRM9R0N03 = Product Type Marking Code

YM = Date Code

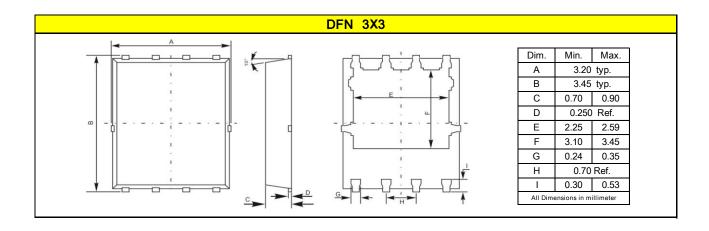
Y = Year code

M = Month code

ABS = Assembly code

## 4. Package information

Package Outline Dimensions millimeters





Version 4.0 6 / 7

## 5. Ordering information

Part Number	Package	Delivery mode
PRM9R0N03N3	DFN 3X3	5000 pcs / 13" diameter reel

#### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
Device Weight: 0.0025 ounces (0.072grams) – DFN 3X3

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Version 4.0 7 / 7